502773068 04/17/2014

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT2819663

		NEW ASSIGNMENT	
ATURE OF CONVEYANCE:		ASSIGNMENT	
CONVEYING PARTY DA	ATA		
		Name	Execution Date
CHUN-WEI CHANG			04/17/2014
KUEI-WEI CHEN			04/17/2014
CHIA-MING CHENG			04/17/2014
CHIA-SHENG LIN			04/17/2014
CHIEN-HUI CHEN			04/17/2014
TSANG-YU LIU			04/17/2014
RECEIVING PARTY DA	тл		
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Street Address:	9F., NO. 23, JILIN RD.		
City:	ZHONGLI CITY, TAOYUAN COUNTY		
State/Country:	TAIWAN		
Postal Code:	320		
PROPERTY NUMBERS Total: 1 Property Type		Number	
Application Number:		14255872	
CORRESPONDENCE DATA Fax Number: (2		(212)820 5741	
		(213)830-5741 o the e-mail address first; if that is unsu	uccessful. it will be sent via
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		wliu@liulaw.com WEN LIU	
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Addroce Line 1.		LOS ANGELES, CALIFORNIA 90071	
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Address Line 4: TTORNEY DOCKET NU	IMBER:	1314/214A	
ATTORNEY DOCKET NU IAME OF SUBMITTER:	IMBER:	1314/214A WEN LIU	
Address Line 1: Address Line 4: ATTORNEY DOCKET NU NAME OF SUBMITTER: BIGNATURE: DATE SIGNED:	IMBER:	1314/214A	

Inventor(s)-to-Assignce

ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title)_____

WAFER LEVEL ARRAY OF CHIPS AND METHOD THEREOF

The PATENT RIGHTS referred to in this agreement are:

(*check one*) a patent application for this invention, executed by the ASSIGNOR(S)

concurrently with this assignment.

U.S. patent application Serial No._____,filed_____

I a U.S. patent application based on PCT International Application

No._____filed on (date)_____(U.S. patent application

Serial No._____, if known).

U.S. patent No.____, issued_____

The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

(check one) 🛛 U.S. patent rights only.

Worldwide patent rights. In this case, the assignee shall have the right to claim the benefit of the filing date of any U.S. or foreign patent application for this invention.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures appear on page 2 of this Assignment and any Supplemental Sheet(s).

The ASSIGNEE referred to in this agreement is:

(Name of Assignee) Xintec Inc.

(Address) 9F., No.23, Jilin Rd., Zhongli City, Taoyuan County 320, Taiwan, R.O.C.

The ASSIGNEE is:

(check one) An individual.

A Partnership.

A Corporation of <u>TAIWAN, R.O.C.</u> (specify state or country)

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;

the entire right, title and interest in and to the PATENT RIGHTS;

the right to sue and recover for any past infringement; and

the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable

provisions, based on any earlier patent applications for this invention.

PATENT REEL: 032704 FRAME: 0202

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO ASSIGNEE: <u>Xintec Inc.</u> INVENTION TITLE:

WAFER LEVEL ARRAY OF CHIPS AND METHOD THEREOF

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

Signature

Signature

Signature

hia

Chun-Wei CHANG Name of sole or first inventor

Kuei-Wei CHEN

Name of second inventor, if any

Chia-Ming CHENG Name of third inventor, if any

Chia-Sheng LIN Name of fourth inventor, if any

Chien-Hui CHEN Name of fifth inventor, if any

Tsang-Yu LIU Name of sixth inventor, if any

2014/04/17

Date

Date

2014/04/17

2014/04/17

Date

2014/04/17

2014/04/17

Date

Signature

2014/04/17

Date

Date

PATENT REEL: 032704 FRAME: 0203

RECORDED: 04/17/2014